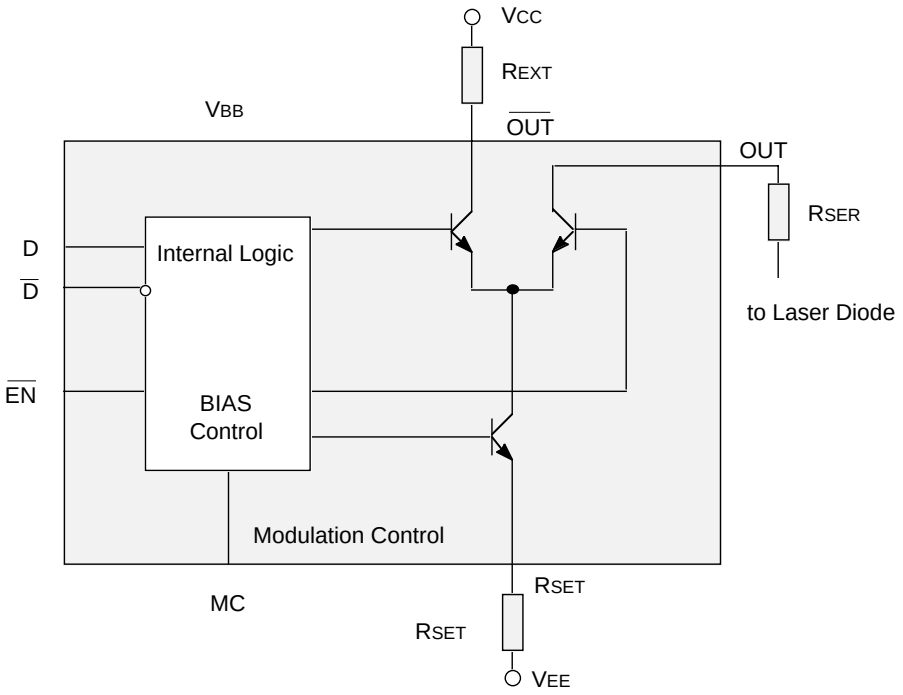
Up to 1.25Gbps operation

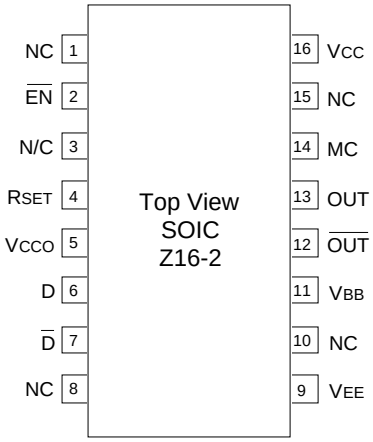
- **75mA peak drive current**
- **Separate modulation control**
- **Separate output enable for laser safety**
- **Differential inputs for data**
- **75KΩ input pulldown resistor**
- **Single power supply**
- **Available in 16-pin SOIC package**

The SY100EL1003 is a high speed current source for driving a semiconductor laser diode in optical transmission applications. The output current modulation is DC – voltage controlled. The modulation current is disabled when output enable is HIGH.

The device incorporates complementary open collector outputs with a capability of driving peak current of 75mA. The laser driver current is adjustable by selection of RSET. The resistor REXT must be placed between $\overline{OUT}$ and VCC to dissipate the worst case power. RSER is recommended to fix laser diode matching issues.

The SY100EL1003 utilizes the high performance bipolar ASSET technology.





16-Pin Narrow SOIC (Z16-2)

(1)

Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY100EL1003ZC	Z16-2	Commercial	SY100EL1003ZC	Sn-Pb
SY100EL1003ZCTR[2]	Z16-2	Commercial	SY100EL1003ZC	Sn-Pb
SY100EL1003ZI	Z16-2	Industrial	SY100EL1003ZI	Sn-Pb
SY100EL1003ZITR[2]	Z16-2	Industrial	SY100EL1003ZI	Sn-Pb
SY100EL1003ZG[3]	Z16-2	Industrial	SY100EL1003ZG with Pb-Free bar-line indicator	Pb-Free NiPdAu
SY100EL1003ZGTR[2, 3]	Z16-2	Industrial	SY100EL1003ZG with Pb-Free bar-line indicator	Pb-Free NiPdAu

Notes:

1. Contact factory for die availability. Dice are guaranteed at T_A = 25°C, DC Electricals only.
2. Tape and Reel.
3. Pb-Free package is recommended for new designs.

Pin	Function
V_{CC}, V_{CCO}	Separate positive power supply pins help to isolate sensitive circuitry from noise generating function. +5V for PECL operation or ground for ECL operation.
V_{EE}	Most negative power supply input. Ground for PECL operation or -5V for ECL operation.
V_{BB}	This pin provides a reference voltage for use in single ended applications or when the input signal is AC coupled into the device.
D,$\overline{D}$	These differential ECL/PECL 100K compatible inputs receive NRZ data.
$\overline{EN}$	This ECL/PECL 100K compatible input enables Laser Driver - modulation current transitions to zero when asserted HIGH.
OUT, $\overline{OUT}$	Open collector outputs from the modulation buffer drive these differential current outputs.
MC	An external voltage sets the main value of modulation current I_O.
R_{SET}	An external resistor sets the source current for modulation I_{mod}.
NC	These pins are not connected.

D	$\overline{D}$	$\overline{EN}$	OUT	$\overline{OUT}$
L	H	L	H	L
H	L	L	L	H
X	X	H	H	L

NOTE:

1. L = LOW, H = HIGH, X = don't care

Symbol	Rating	Value	Unit
V_{EE}	Power Supply Voltage (V_{CC} = 0V)	0 to -7.0	V
V_{IN}	Input Voltage (V_{CC} = 0V)	0 to -6.0	V
I_{OUT}	Output Current	75	mA
T_{LEAD}	Lead Temperatre (soldering, 20sec.)	+260°	°C
T_A	Operating Temperature Range	–40 to +85°	°C
P_{tot}	Power Dissipation	500	mW

Note:

1. Permanent device damage may occur if absolute maximum ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum ratlng conditions for extended periods may affect device reliability.

V_{EE}	Power Supply Voltage	–4.75 to -5.25	V
R_{SET}	Resistor to Adjust Current	10 to 100	Ω
R_{EXT}	Resistor to Dissipate Power	10 to 50	Ω
R_{SER}	Laser Diode Serial Resistor	0 to 50	Ω

1. The voltage drop across R_{EXT} and R_{SER} should not be greater than 2V.

CC = VCCO = 0V; VEE = -5.0V ± 5%

Symbol	Parameter	TA = –40°C			TA = 0°C			TA = +25°C			TA = +85°C			Unit
		Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	
VIH	Input HIGH Voltage (D, $\overline{EN}$)	-1165	—	-880	-1165	—	-880	-1165	—	-880	-1165	—	-880	mV
VIL	Input LOW Voltage (D, $\overline{EN}$)	-1810	—	-1475	-1810	—	-1475	-1810	—	-1475	-1810	—	-1475	mV
VImod	Input Voltage (Modulation Control)	VEE	—	VCC	VEE	—	VCC	VEE	—	VCC	VEE	—	VCC	V
VBB	Output Reference Voltage	-1380	—	-1260	-1380	—	-1260	-1380	—	-1260	-1380	—	-1260	mV
IIH	Input HIGH Current (D, $\overline{EN}$)	—	—	150	—	—	150	—	—	150	—	—	150	µA
IImod	Input Current (Modulation Control)	—	—	150	—	—	150	—	—	150	—	—	150	µA
IIL	Input LOW Current(2) (D, $\overline{EN}$)	0.5	—	—	0.5	—	—	0.5	—	—	0.5	—	—	µA
ICC	Supply Current(3)	8	14	25	8	14	25	8	14	25	8	14	25	mA
IOH	Output HIGH Current(4) ($\overline{EN}$ LOW)(5)	60	64 —	68 —	60 5	64 —	68 —	60 5	64 —	68 —	60 5	64 —	68 —	mA 5
IOL	Output LOW Current ($\overline{EN}$ HIGH)	—	—	500	—	—	500	—	—	500	—	—	500	µA
IOR	Output Current Ringing(6)	—	—	10	—	—	10	—	—	10	—	—	10	%
IOmod	Laser Diode Modulation Current Range	5	—	60	5	—	60	5	—	60	5	—	60	mA

Notes:

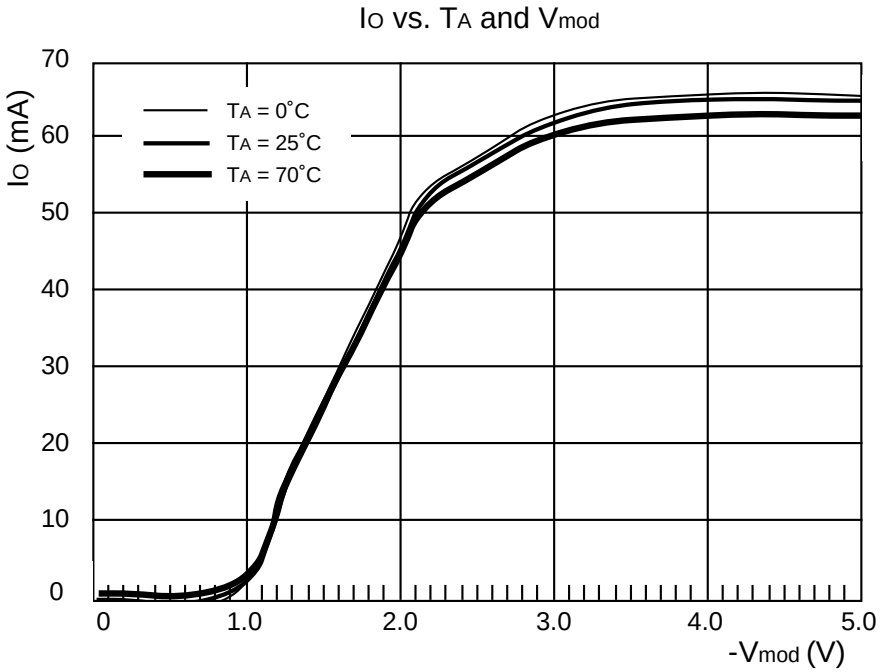
1. RSET = 10Ω ± 1%
2. VI = VIL(Min.)
3. VImod = VCC
4. VImod = -3.5V
5. VLmod = -0.8V
6. IOH = 5 to 60mA

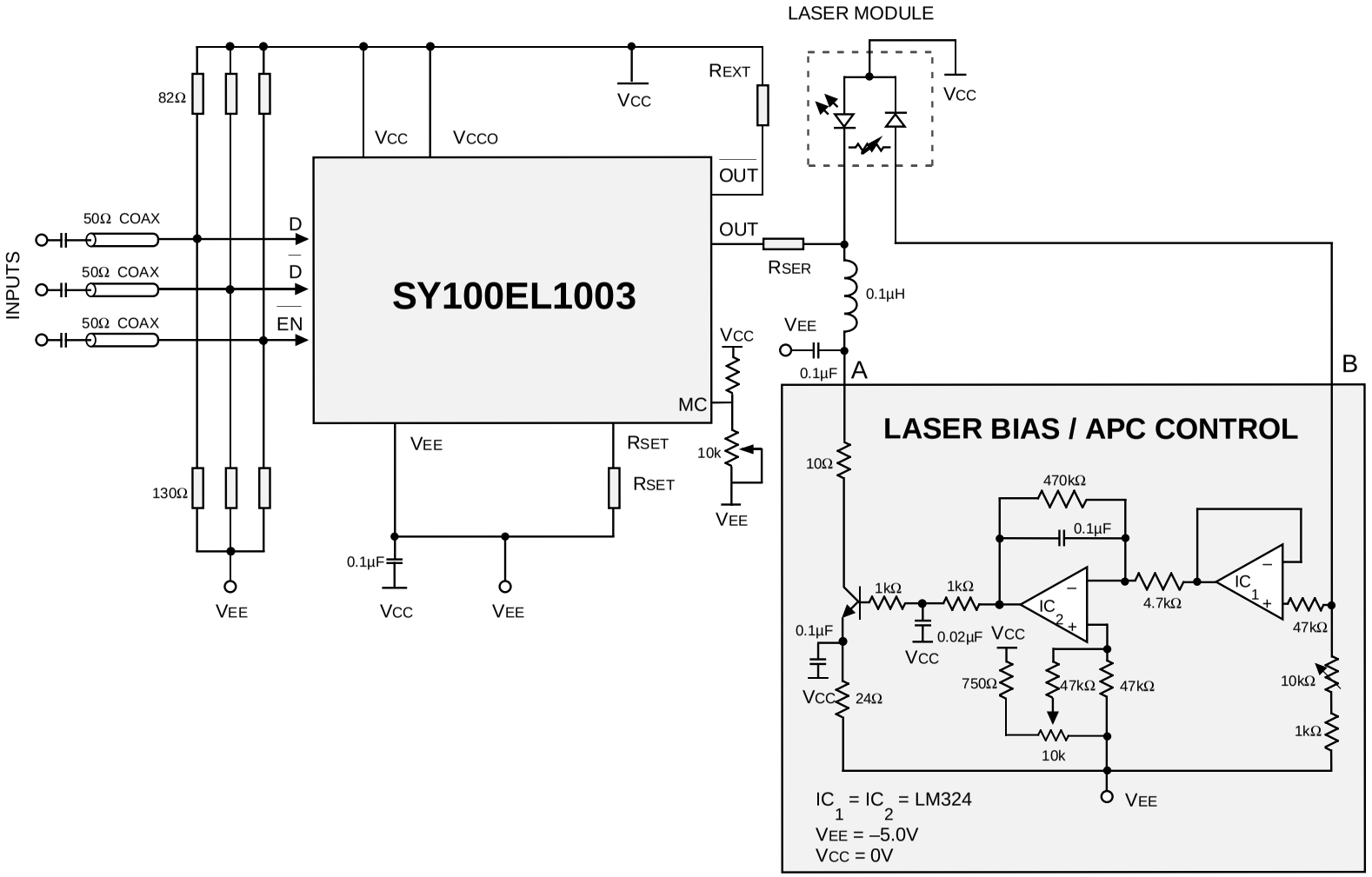
VImod = –1.5V; VCC = VCCO = 0V; VEE = –5V ± 5%

Symbol	Parameter	TA = –40°C			TA = 0°C			TA = +25°C			TA = +85°C			Unit
		Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	
tpd D	Propagation Delay D - OUT	—	—	1000	—	—	1000	—	—	1000	—	—	1000	ps
tpd $\overline{EN}$	Propogation Delay $\overline{EN}$ - OUT	—	—	1000	—	—	1000	—	—	1000	—	—	1000	ps
tr tf	Rise/Fall Time (20% to 80%)	—	—	400	—	—	400	—	—	400	—	—	400	ps

Note:

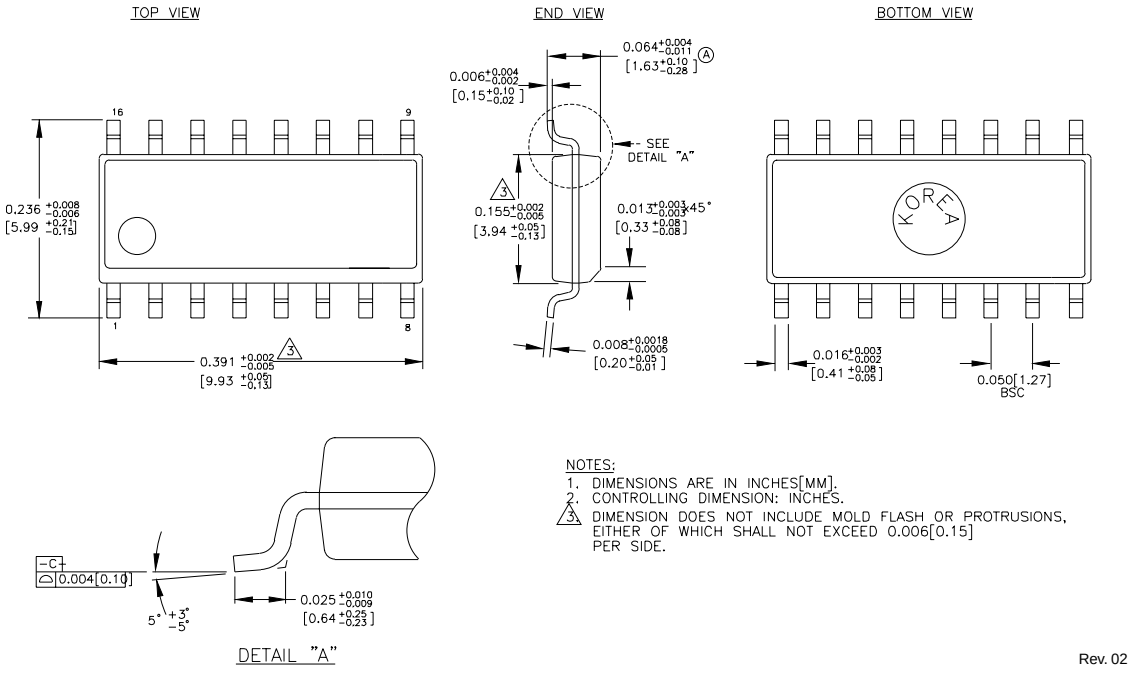
1. RSET = 10Ω ± 1%, REXT = RSER = 50Ω ± 1%


IO vs. TA and Vmod
70
60
50
40
30
20
10
0
IO (mA)
TA = 0˚C
TA = 25˚C
TA = 70˚C
0
1.0
2.0
3.0
4.0
5.0
-Vmod (V)



1. Split 100K ECL terminations are 82Ω and 130Ω to V_{CC} and V_{EE} respectively.
2. Recommended power supply bypass capacitors are 0.1µF with optional 10µF Tantalum in parallel.
3. It is required to use high frequency design techniques for board layout. A double sided or multilayer board is recommended in conjunction with a low impedance ground plane and properly terminated transmission lines for all signal paths.
4. V_{BB} voltage pin may be used as reference for single ended input applications.

M9999-031306
hbwhelp@micrel.com or (408) 955-1690



NOTES:
1. DIMENSIONS ARE IN INCHES[MM].
2. CONTROLLING DIMENSION: INCHES.
3. DIMENSION DOES NOT INCLUDE MOLD FLASH OR PROTRUSIONS, EITHER OF WHICH SHALL NOT EXCEED 0.006[0.15] PER SIDE.

Rev. 02

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